ABSOCIATION CONNECTING ELECTRONICE INDUSTRIES INDUSTRIES INTO A CONNECTING	ourn, Illinois. All rights reserved un	der both This doc level par	cument is a decla rts, the declaratio	ration of the substa n encompasses all	nces within the manufactur lower level materials for w	rer listed item. N hich the manufa	Note: if the item is an acturer has engineerir	assembly with lower g responsibility.		
1752-21.1 IPC Web Site for Information on I http://www.ipc.org/IPC-175x	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute			Declaration Class * Class 6 - RoHS Yes	/No, Homogeneous Materi	als and Mfg Information				
Supplier Information										
mpany name* Company unique ID			Unique ID Authority			Response Date*				
onsemi	emi					2023-06-08				
Contact Name	ame Title - Contact			Phone - Contact*			Email - Contact*			
Product-Env-Stewards	ct-Env-Stewards Product Enviro Compliance		NA			Product-Env-Stewards@onsemi.com				
Authorized Representative*	horized Representative* Title - Representative		Phone - Representative*			Email - Representative*				
Product-Env-Stewards Product Enviro Compliance			NA			Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr Item	Number Mfr Item Name	Mfr Item Name		ate Version	Manufacturing Site	Weigh	nt* UOM	Unit Type		
NCP137 G	AFCTADJT2 700 mA, Very Low CMOS Voltage Re	v Dropout Bias Rail gulator	2023-06-08		CNQ	0.7020	)6 mg	Each		
Manufacturing Proccess Information										
Terminal Plating / Grid Array Material	Ferminal Base Alloy J-	STD-020 MSL Rating	Peak P	Peak Process Body Temperature Max Tim		Temperature Number of Reflow Cycles		ycles		
Matte Tin (Sn) - annealed CU Alloy 1			260	С	30	seconds	3			
Comments										
level 1 - maximum time at peak temperature during so	ldering is 10-30 seconds									
For more information regarding material composition	please refer to page 3									

RoHS Material Composition Declaration				Declaration Type *	Detailed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIP).								
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of				
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all				
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the				
Supplier Digital Signature Ra	stislav Drska	Le							

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).									
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	0.52992	mg	Supplier	Silicon (Si)	7440-21-3		0.5299	mg	
Plating	0.10106	mg	Supplier	Tin (Sn)	7440-31-5		0.1011	mg	
Protection coat	0.01363	mg		Polyimide	proprietary data		0.0136	mg	
RDL	0.02674	mg	Supplier	Titanium (Ti)	7440-32-6		0.0002	mg	
			Supplier	Copper (Cu)	7440-50-8		0.0265	mg	
UBM Sputter 0.030	0.03071	mg	Supplier	Titanium (Ti)	7440-32-6		0.0002	mg	
		-	Supplier	Copper (Cu)	7440-50-8		0.0306	mg	